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PATENT Atty. Dkt. No. AMAT/5262/CMP/CMP/RKK

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

n re Application of:

Tsai, et al.

Serial No.: 09/961,134

Filed:

September 21, 2001

Confirmation No.: 4110

For:

Method and Apparatus for

Forming Metal Layers

Assistant Commissioner for

Patents

Washington, D.C. 20231

Dear Sir:

Group Art Unit: 1741

Examiner:

Unknown

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I hereby certify that this correspondence is being deposited on 4//5, 2002 with the United States Postal Service as First Class Mail in an envelope addressed to: Assistant Commissioner for Patents, Washington, D.C. 2023

4,5/02

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REQUEST FOR CORRECTION OF ERROR ON FILING RECEIPT

The Filing Receipt for the above-referenced application contains an error regarding the addressee section. Please delete [3050 Bowers Avenue] from the addressee section. The addressee section should read:

Patent Counsel

Applied Materials, Inc.

P.O. Box 450A

Santa Clara, CA 95052.

Attached is a copy of the Filing Receipt with the above change noted thereon. Please correct this error or notify the applicants of the reasons for denying the request.

Respectfully submitted,

B. Todd Patterson

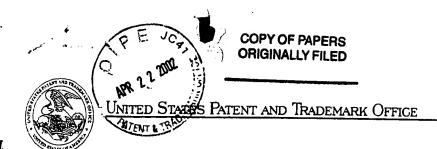
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FILING RECEIPT

POT CLAIMS IND CLAIMS

CONFIRMATION NO. 4110

Patent Counsel Applied Materials, Inc. 12050 Bowers Avenue

P.O. Box 450A Santa Clara, CA 95052 RECD NOV 05 2007

Date Mailed: 10/24/2001

Receipt is acknowledged of this nonprovisional Patent Application. It will be considered in its order and you will be notified as to the results of the examination. Be sure to provide the U.S. APPLICATION NUMBER, FILING DATE, NAME OF APPLICANT, and TITLE OF INVENTION when inquiring about this application. Fees transmitted by check or draft are subject to collection. Please verify the accuracy of the data presented on this receipt. If an error is noted on this Filing Receipt, please write to the Office of Initial Patent Examination's Customer Service Center. Please provide a copy of this Filing Receipt with the changes noted thereon. If you received a "Notice to File Missing Parts" for this application, please submit any corrections to this Filing Receipt with your reply to the Notice. When the USPTO processes the reply to the Notice, the USPTO will g nerate another Filing Receipt incorporating the requested corrections (if appropriate).

Applicant(s)

Stan Tsai, Fremont, CA: v Shijian Li, San Jose, CA: 1

Assignment For Published Patent Application

Applied Materials, Inc.;

Domestic Priority data as claimed by applicant

Foreign Applications

If Required, Foreign Filing License Granted 10/23/2001

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Early Publication Request: No

Title

Method and apparatus for forming metal layers